## MJ15022 (NPN), MJ15024 (NPN)

# **Silicon Power Transistors**

The MJ15022 and MJ15024 are power transistors designed for high power audio, disk head positioners and other linear applications.

#### Features

- High Safe Operating Area
- High DC Current Gain
- These Devices are Pb-Free and are RoHS Compliant\*
- Complementary to MJ15023 (PNP), MJ15025 (PNP)

#### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector–Emitter Voltage MJ15022 MJ15024	V <sub>CEO</sub>	200 250	Vdc
Collector-Base Voltage MJ15022 MJ15024	V <sub>CBO</sub>	350 400	Vdc
Emitter-Base Voltage	V <sub>EBO</sub>	5	Vdc
Collector-Emitter Voltage	V <sub>CEX</sub>	400	Vdc
Collector Current – Continuous	Ι <sub>C</sub>	16	Adc
Collector Current – Peak (Note 1)	I <sub>CM</sub>	30	Adc
Base Current – Continuous	Ι <sub>Β</sub>	5	Adc
Total Device Dissipation @ T <sub>C</sub> = 25°C Derate above 25°C	PD	250 1.43	W W/°C
Operating and Storage Junction Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-65 to +200	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. Pulse Test: Pulse Width = 5 ms, Duty Cycle  $\leq$  10%.

#### THERMAL CHARACTERISTICS

Characteristics	Symbol	Мах	Unit
Thermal Resistance, Junction-to-Case	$R_{ extsf{ heta}JC}$	0.70	°C/W

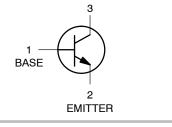


## **ON Semiconductor®**

http://onsemi.com

## 16 AMPERES SILICON POWER TRANSISTORS 200 – 250 VOLTS, 250 WATTS

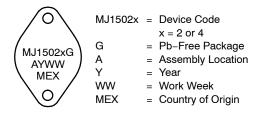
SCHEMATIC CASE 3







#### MARKING DIAGRAM



### ORDERING INFORMATION

Device	Package	Shipping
MJ15022G	TO–204 (Pb–Free)	100 Units / Tray
MJ15024G	TO–204 (Pb–Free)	100 Units / Tray

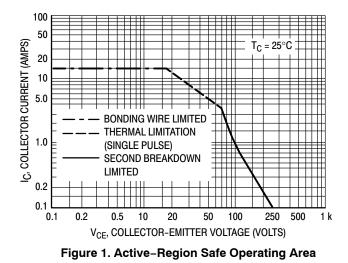
\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

## MJ15022 (NPN), MJ15024 (NPN)

#### **ELECTRICAL CHARACTERISTICS** (T<sub>C</sub> = 25°C unless otherwise noted)

Characteristic		Symbol	Min	Max	Unit
OFF CHARACTERISTICS					
Collector-Emitter Sustaining Voltage (Note 2) $(I_C = 100 \text{ mAdc}, I_B = 0)$	MJ15022 MJ15024	V <sub>CEO(sus)</sub>	200 250		-
Collector Cutoff Current ( $V_{CE}$ = 200 Vdc, $V_{BE(off)}$ = 1.5 Vdc) ( $V_{CE}$ = 250 Vdc, $V_{BE(off)}$ = 1.5 Vdc)	MJ15022 MJ15024	I <sub>CEX</sub>	-	250 250	μAdc
Collector Cutoff Current ( $V_{CE} = 150 \text{ Vdc}, I_B = 0$ ) ( $V_{CE} = 200 \text{ vdc}, I_B = 0$ )	MJ15022 MJ15024	I <sub>CEO</sub>		500 500	μAdc
Emitter Cutoff Current ( $V_{CE} = 5 \text{ Vdc}, I_B = 0$ )		I <sub>EBO</sub>	-	500	μAdc
SECOND BREAKDOWN					
Second Breakdown Collector Current with Base Forward Biased (V <sub>CE</sub> = 50 Vdc, t = 0.5 s (non-repetitive)) (V <sub>CE</sub> = 80 Vdc, t = 0.5 s (non-repetitive))		I <sub>S/b</sub>	5 2		Adc
ON CHARACTERISTICS					-
DC Current Gain ( $I_C = 8 \text{ Adc}, V_{CE} = 4 \text{ Vdc}$ ) ( $I_C = 16 \text{ Adc}, V_{CE} = 4 \text{ Vdc}$ )		h <sub>FE</sub>	15 5	60 -	-
Collector–Emitter Saturation Voltage ( $I_C = 8 \text{ Adc}, I_B = 0.8 \text{ Adc}$ ) ( $I_C = 16 \text{ Adc}, I_B = 3.2 \text{ Adc}$ )		V <sub>CE(sat)</sub>	-	1.4 4.0	Vdc
Base-Emitter On Voltage (I <sub>C</sub> = 8 Adc, V <sub>CE</sub> = 4 Vdc)		V <sub>BE(on)</sub>	_	2.2	Vdc
DYNAMIC CHARACTERISTICS			-	•	
Current–Gain – Bandwidth Product ( $I_C = 1 \text{ Adc}, V_{CE} = 10 \text{ Vdc}, f_{test} = 1 \text{ MHz}$ )		f <sub>T</sub>	4	-	MHz
Output Capacitance ( $V_{CB}$ = 10 Vdc, $I_E$ = 0, $f_{test}$ = 1 MHz)		C <sub>ob</sub>	-	500	pF

2. Pulse Test: Pulse Width = 300  $\mu$ s, Duty Cycle  $\leq$  2%.

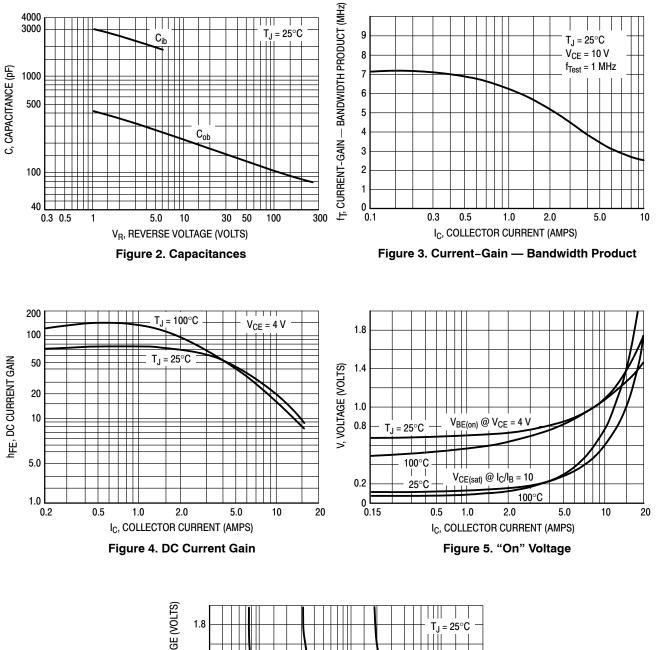


There are two limitations on the powerhandling ability of a transistor: average junction temperature and second breakdown. Safe operating area curves indicate  $I_C - V_{CE}$  limits of the transistor that must be observed for reliable operation; i.e., the transistor must not be subjected to greater dissipation than the curves indicate.

The data of Figure 1 is based on  $T_{J(pk)} = 200^{\circ}$ C;  $T_{C}$  is variable depending on conditions. At high case temperatures, thermal limitations will reduce the power that can be handled to values Ion than the limitations imposed by second breakdown.

## MJ15022 (NPN), MJ15024 (NPN)

### **TYPICAL CHARACTERISTICS**



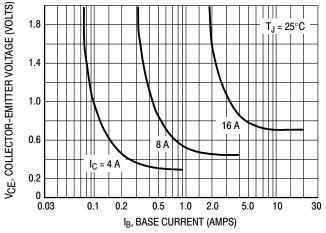


Figure 6. Collector Saturation Region

#### MECHANICAL CASE OUTLINE PACKAGE DIMENSIONS



DIMENSIONS					,
SCALE 1:1	TO–204 (T CASE 1- ISSUE	-07		DATE 05/18/1988	3
$ \begin{array}{c}                                     $		2. 3.	SS:         DIMENSIONING AND TOLE         ZONTROLLING DIMENSIO         ALL RULES AND NOTES A         REFERENCED TO-204AA         INCHES         DIM         MIN         MAX         A         1.550 REF         B            1.050         C         0.250         0.335         D         0.336         0.038         0.403         B            0.330         0.430         B         0.215         SSC         N            0.330         Q         0.151         0.165         U         1.187         BSC         V         0.131         0.181	DN: INCH. ASSOCIATED WITH	
PIN 1. BASE 2. EMITTER CASE: COLLECTOR STYLE 6:	STYLE 2: STYLE 3: PIN 1. BASE PIN 1. GAT 2. COLLECTOR 2. SOU CASE: EMITTER CASE: DRA STYLE 7: STYLE 8:	RCE 2. INPUT IN CASE: OUTPUT STYLE 9:	style 5: Pin 1. cathode 2. external Case: Anode		
PIN 1. GATE 2. EMITTER CASE: COLLECTOR	PIN 1. ANODE PIN 1. CATI 2. OPEN 2. CATI CASE: CATHODE CASE: ANO	HODE #2 2. ANODE #2	2		

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